

HETERO JUNCTION FIELD EFFECT TRANSISTOR

NE3510M04

L TO S BAND LOW NOISE AMPLIFIER N-CHANNEL HJ-FET

FEATURES

· Low noise figure and high associated gain

NF = 0.45 dB TYP., G_a = 16 dB TYP. @ f = 4 GHz, V_{DS} = 2 V, I_D = 15 mA NF = 0.35 dB TYP., G_a = 19 dB TYP. @ f = 2 GHz, V_{DS} = 2 V, I_D = 10 mA (Reference only)

· Flat-lead 4-pin thin-type super minimold (M04) package

APPLICATIONS

- · Satellite radio (SDARS, DMB, etc.) antenna LNA
- · Low noise amplifier for microwave communication system

ORDERING INFORMATION

Part Number	Order Number	Package	Quantity	Marking	Supplying Form
NE3510M04	NE3510M04-A	Flat-lead 4-pin thin-	50 pcs (Non reel)	V81	8 mm wide embossed taping
NE3510M04-T2	NE3510M04-T2-A	type super minimold (M04) (Pb-Free)	3 kpcs/reel		• Pin 1 (Source), Pin 2 (Drain) face the perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: NE3510M04-A

ABSOLUTE MAXIMUM RATINGS ($T_A = +25$ °C)

Parameter	Symbol	Ratings	Unit
Drain to Source Voltage	V _{DS}	4.0	V
Gate to Source Voltage	V _{GS}	-3.0	٧
Drain Current	lσ	loss	mA
Gate Current	lg	140	μΑ
Total Power Dissipation	Ptot Note	125	mW
Channel Temperature	Tch	+150	°C
Storage Temperature	T _{stg}	-65 to +150	°C

Note Mounted on 1.08 cm² x 1.0 mm (t) glass epoxy PCB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

Document No. PG10676EJ01V0DS (1st edition) Date Published July 2007 NS

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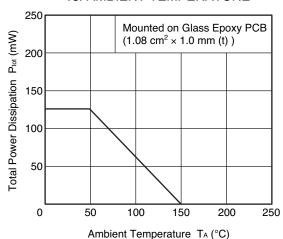
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Drain to Source Voltage	VDS	-	2	3	V
Drain Current	ΙD	-	15	30	mA
Input Power	Pin	-	-	0	dBm

ELECTRICAL CHARACTERISTICS (T_A = +25°C, unless otherwise specified)

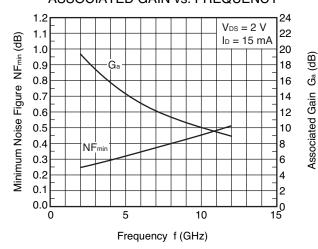
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Gate to Source Leak Current	Igso	Vgs = -3 V	-	0.5	10	μA
Saturated Drain Current	IDSS	V _{DS} = 2 V, V _{GS} = 0 V	42	70	97	mA
Gate to Source Cutoff Voltage	V _{GS} (off)	$V_{DS} = 2 \text{ V}, I_{D} = 100 \ \mu\text{A}$	-0.35	-0.7	-1.10	V
Transconductance	g _m	V _{DS} = 2 V, I _D = 15 mA	70	-	-	mS
Noise Figure	NF	V _{DS} = 2 V, I _D = 15 mA, f = 4 GHz	-	0.45	0.65	dB
Associated Gain	Ga		14.5	16	-	dB
Gain 1 dB Compression	Po (1 dB)	V _{DS} = 2 V, I _D = 15 mA (Non-RF),	-	+11	-	dBm
Output Power		f = 4 GHz				

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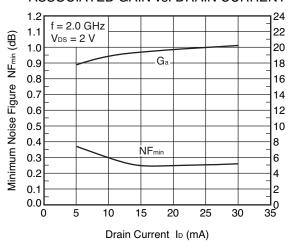
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



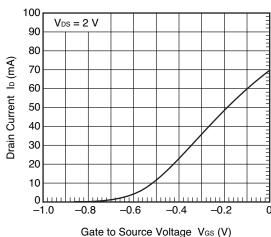
MINIMUM NOISE FIGURE, ASSOCIATED GAIN vs. FREQUENCY



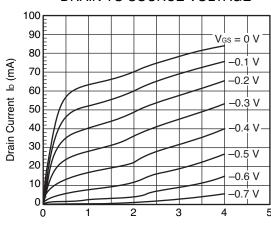
MINIMUM NOISE FIGURE, ASSOCIATED GAIN vs. DRAIN CURRENT



DRAIN CURRENT vs. GATE TO SOURCE VOLTAGE

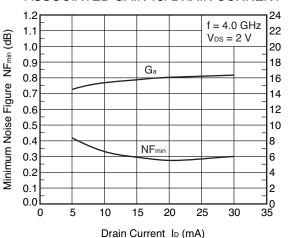


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



Drain to Source Voltage VDS (V)

MINIMUM NOISE FIGURE, ASSOCIATED GAIN vs. DRAIN CURRENT

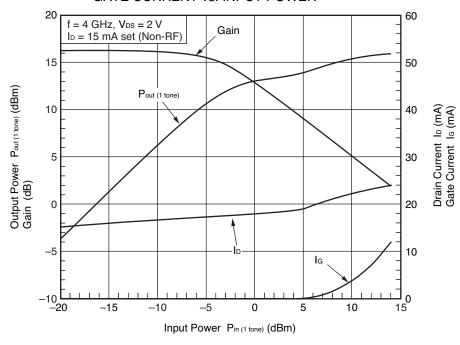


Remark The graphs indicate nominal characteristics.

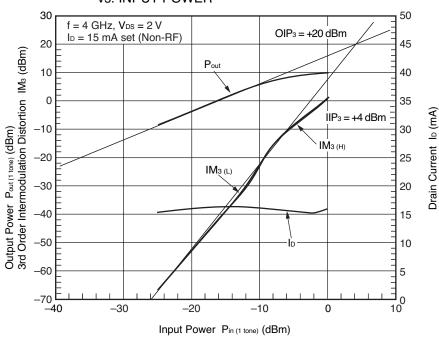
Ga (dB)

Associated Gain

查询"NE3510M04-T2-A"供应的PUT POWER, GAIN, DRAIN CURRENT, GATE CURRENT vs. INPUT POWER



OUTPUT POWER, IM3, DRAIN CURRENT vs. INPUT POWER



Remark The graphs indicate nominal characteristics.

查**\$何⁴ARA\$Me1tens**T2-A"供应商

S-parameters/Noise parameters are provided on our web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

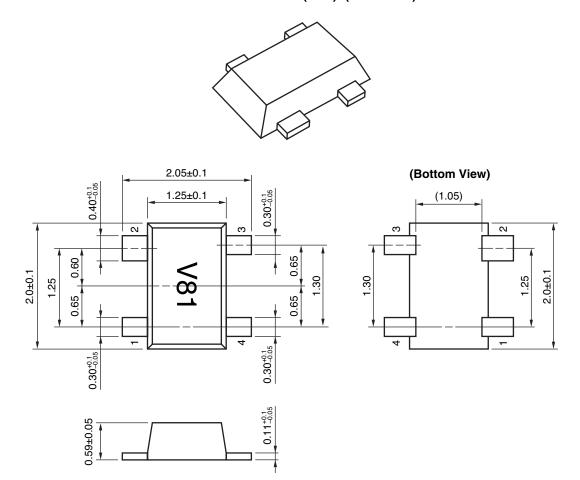
Click here to download S-parameters.

[RF and Microwave] → [Device Parameters]

URL http://www.ncsd.necel.com/microwave/index.html

查例以KAGEOMMENSION供应商

FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04) (UNIT: mm)

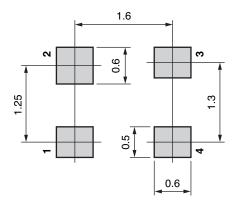


PIN CONNECTIONS

- 1. Source
- 2. Drain
- 3. Source
- 4. Gate

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FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04) PACKAGE (UNIT: mm)



查施设的MMENDED TSOADERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

查询"NE3510M04-T2-A"供应商

- The information in this document is current as of July, 2007. The information is subject to change
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查	询"NE35 10M04-T2-A"	無於商uct uses gallium arsenide (GaAs).
	GaAS Products	GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
		• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
		Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
		Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
		Do not burn, destroy, cut, crush, or chemically dissolve the product.
		Do not lick the product or in any way allow it to enter the mouth.



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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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